

3.2mmx1.6mm SMD CHIP LED LAMP

Part Number: APT3216SECK/J3-PRV Hyper Red

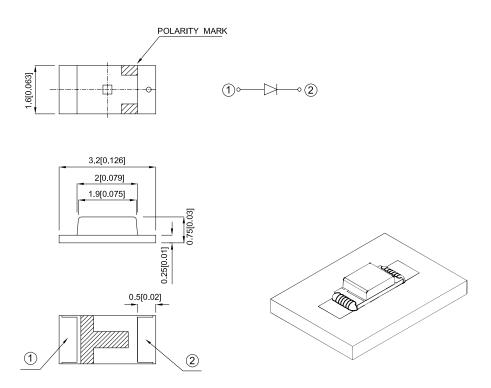
Features

- 3.2mmx1.6mm SMT LED, 0.75mm thickness.
- Low power consumption.
- Wide viewing angle.
- Ideal for backlight and indicator.
- Package : 2000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

Description

The Hyper Red device is based on light emitting diode chip made from AlGaInP.

Package Dimensions



- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.2(0.008")$ unless otherwise noted.
- The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
 The device has a single mounting surface. The device must be mounted according to the specifications.





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Selection Guide

| Part No. | Dice | Lens Type | lv (mcd) [2] @ 20mA | | Viewing Angle [1] |
|--------------------|---------------------|-------------|------------------------|------|----------------------|
| | | | Min. | Тур. | 201/2 |
| ADT2246SECK/12 DDV | Liver Ded (AlCeleD) | Matau Class | 700 | 1100 | 120° |
| APT3216SECK/J3-PRV | Hyper Red (AlGaInP) | Water Clear | *200 | *350 | |

Notes:

- $1. \theta 1/2$ is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
- Luminous intensity/ luminous Flux: +/-15%.
 Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at TA=25°C

| Symbol | Parameter | Device | Тур. | Max. | Units | Test Conditions |
|--------|--------------------------|-----------|------|------|-------|-----------------|
| λpeak | Peak Wavelength | Hyper Red | 640 | | nm | IF=20mA |
| λD [1] | Dominant Wavelength | Hyper Red | 625 | | nm | IF=20mA |
| Δλ1/2 | Spectral Line Half-width | Hyper Red | 20 | | nm | IF=20mA |
| С | Capacitance | Hyper Red | 27 | | pF | VF=0V;f=1MHz |
| VF [2] | Forward Voltage | Hyper Red | 2.2 | 2.8 | V | IF=20mA |
| lr | Reverse Current | Hyper Red | | 10 | uA | VR=5V |

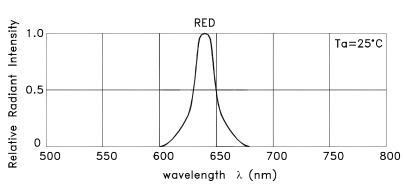
- 1.Wavelength: +/-1nm.
- 2.Forward Voltage: +/-0.1V.
- 3. Wavelength value is traceable to the CIE127-2007 compliant national standards.
- 4.Excess driving current and/or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

Absolute Maximum Ratings at TA=25°C

| Abbolato maximum ratingo at 171 20 0 | | | | | |
|--------------------------------------|----------------|-------|--|--|--|
| Parameter | Hyper Red | Units | | | |
| Power dissipation | 84 | mW | | | |
| DC Forward Current | 30 | mA | | | |
| Peak Forward Current [1] | 150 | mA | | | |
| Reverse Voltage | 5 | V | | | |
| Operating Temperature | -40°C To +85°C | | | | |
| Storage Temperature | -40°C To +85°C | | | | |
| | | | | | |

1. 1/10 Duty Cycle, 0.1ms Pulse Width.

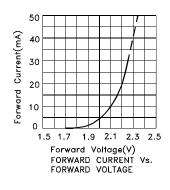
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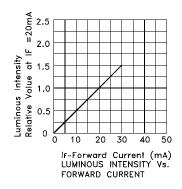


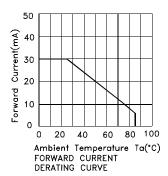
RELATIVE INTENSITY Vs. WAVELENGTH

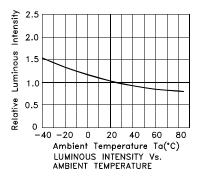
Hyper Red

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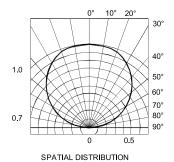






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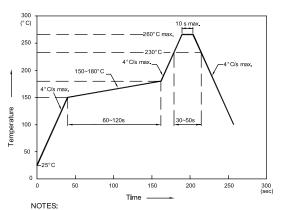
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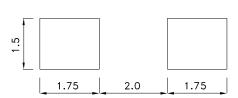
Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.

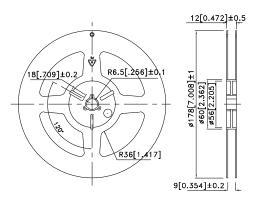


- 1. We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.
- 2.Don't cause stress to the epoxy resin while it is exposed to high temperature
- to high temperature.
 3.Number of reflow process shall be 2 times or less.

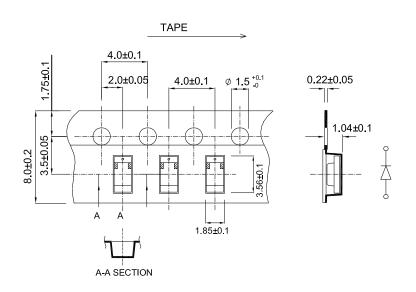
Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



Reel Dimension



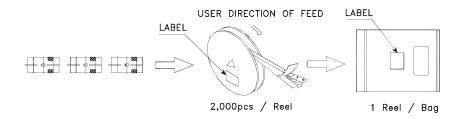
Tape Dimensions (Units : mm)

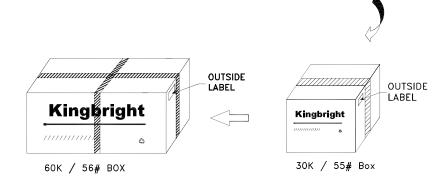


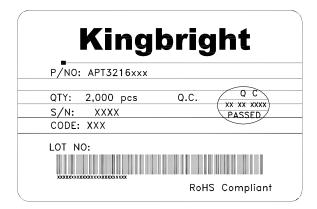
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PACKING & LABEL SPECIFICATIONS

APT3216SECK/J3-PRV







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